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What is "Embedded - Microcontrollers"?

"Embedded - Microcontrollers" refer to small, integrated circuits designed to perform specific tasks within larger systems. These microcontrollers are essentially compact computers on a single chip, containing a processor core, memory, and programmable input/output peripherals. They are called "embedded" because they are embedded within electronic devices to control various functions, rather than serving as standalone computers. Microcontrollers are crucial in modern electronics, providing the intelligence and control needed for a wide range of applications.

Applications of "Embedded - Microcontrollers"

Details	
Product Status	Obsolete
Core Processor	M32C/80
Core Size	16/32-Bit
Speed	32MHz
Connectivity	EBI/EMI, I²C, IEBus, IrDA, SIO, UART/USART
Peripherals	DMA, POR, PWM, WDT
Number of I/O	85
Program Memory Size	1MB (1M x 8)
Program Memory Type	FLASH
EEPROM Size	4K x 8
RAM Size	48K x 8
Voltage - Supply (Vcc/Vdd)	3V ~ 5.5V
Data Converters	A/D 26x10b; D/A 2x8b
Oscillator Type	Internal
Operating Temperature	-20°C ~ 85°C (TA)
Mounting Type	Surface Mount
Package / Case	100-BQFP
Supplier Device Package	100-QFP (14x20)
Purchase URL	https://www.e-xfl.com/product-detail/renesas-electronics-america/m30879flbfp-u5

1.1.2 Specifications

Tables 1.1 to 1.4 list the specifications of the M32C/87 Group (M32C/87, M32C/87A, M32C/87B).

Table 1.1 Specifications (144-Pin Package) (1/2)

Item	Function	Specification
CPU	Central processing unit	M32C/80 core (multiplier: 16 bits × 16 bits → 32 bits multiply-addition operation instructions: 16 × 16 + 48 → 48 bits) • Basic instructions: 108 • Minimum instruction execution time: 31.3 ns (f(CPU) = 32 MHz, VCC1 = 4.2 to 5.5 V) 41.7 ns (f(CPU) = 24 MHz, VCC1 = 3.0 to 5.5 V) • Operating modes: Single-chip mode, memory expansion mode, and microprocessor mode
Memory	ROM, RAM, data flash	See **Tables 1.5 to 1.7 Product List**.
Power Supply Voltage Detection		Vdet3 detection function, Vdet4 detection function, cold start/warm start determination function
External Bus Expansion	Bus/memory expansion function	• Address space: 16 Mbytes • External bus interface: 1 to 7 wait states can be inserted, 4 chip select outputs, 3 V and 5 V interfaces • Bus format: Switchable between separate bus and multiplexed bus formats, switchable data bus width (8-bit or 16-bit)
Clock	Clock generation circuits	• 4 circuits: Main clock, sub clock, on-chip oscillator, PLL frequency synthesizer • Oscillation stop detection: Main clock oscillation stop detection function • Frequency divider circuit: Dividing ratio selectable among 1, 2, 3, 4, 6, 8, 10, 12, 14, 16 • Low power consumption features: Wait mode, stop mode
Interrupts		• Interrupt vectors: 70 • External interrupt inputs: 14 ($\overline{\text{NMI}}$, $\overline{\text{INT}}$ × 9, key input × 4) • Interrupt priority levels: 7
Watchdog Timer		15-bit × 1 channel (with prescaler)
DMA	DMAC	• 4 channels, cycle steal method • Trigger sources: 43 • Transfer modes: 2 (single transfer and repeat transfer)
	DMACII	• Can be activated by all peripheral function interrupt sources • Transfer modes: 2 (single transfer and burst transfer) • Immediate transfer, calculation transfer, and chain transfer functions
Timer	Timer A	16-bit timer × 5 Timer mode, event counter mode, one-shot timer mode, pulse width modulation (PWM) mode, Event counter 2-phase pulse signal processing (2-phase encoder input) × 3
	Timer B	16-bit timer × 6 Timer mode, event counter mode, pulse period measurement mode, pulse width measurement mode
	Timer function for 3-phase motor control	3-phase inverter control × 1 (using timer A1, timer A2, timer A4, and timer B2) On-chip dead time timer

1.2 Product List

Tables 1.5 to 1.7 list product information. Figure 1.1 shows product numbering system.

Table 1.5 M32C/87 Group (1) (M32C/87: 2-channel CAN module) Current as of Jul. 2008

Part Number	Package Code	ROM Capacity	RAM Capacity	Remarks
M3087BFLGP	PLQP0144KA-A (144P6Q-A)	1 MB + 4 KB(1)	48 KB	Flash memory
M30879FLFP	PRQP0100JB-A (100P6S-A)			
M30879FLGP	PLQP0100KB-A (100P6Q-A)			
M3087BFKGP	PLQP0144KA-A (144P6Q-A)	768 KB + 4 KB(1)		
M30879FKGP	PLQP0100KB-A (100P6Q-A)			
M30878FJGP	PLQP0144KA-A (144P6Q-A)	512 KB + 4 KB(1)	31 KB	
M30876FJGP	PLQP0100KB-A (100P6Q-A)			
M30875FHGP	PLQP0144KA-A (144P6Q-A)	384 KB + 4 KB(1)	24 KB	
M30873FHGP	PLQP0100KB-A (100P6Q-A)			
M30878MJ-XXXGP	PLQP0144KA-A (144P6Q-A)	512 KB	31 KB	Mask ROM
M30876MJ-XXXFP	PRQP0100JB-A (100P6S-A)			
M30876MJ-XXXGP	PLQP0100KB-A (100P6Q-A)			
M30875MH-XXXGP	PLQP0144KA-A (144P6Q-A)	384 KB	24 KB	
M30873MH-XXXGP	PLQP0100KB-A (100P6Q-A)			

NOTE:
1. Additional 4-Kbyte space is available for data flash memory.

Table 1.6 M32C/87 Group (2) (M32C/87A: 1-channel CAN module) Current as of Jul. 2008

Part Number	Package Code	ROM Capacity	RAM Capacity	Remarks
M3087BFLAGP	PLQP0144KA-A (144P6Q-A)	1 MB + 4 KB(1)	48 KB	Flash memory
M30879FLAFP	PRQP0100JB-A (100P6S-A)			
M30879FLAGP	PLQP0100KB-A (100P6Q-A)			
M3087BFKAGP	PLQP0144KA-A (144P6Q-A)	768 KB + 4 KB(1)		
M30879FKAGP	PLQP0100KB-A (100P6Q-A)			
M30878FJAGP	PLQP0144KA-A (144P6Q-A)	512 KB + 4 KB(1)	31 KB	
M30876FJAGP	PLQP0100KB-A (100P6Q-A)			
M30875FHAGP	PLQP0144KA-A (144P6Q-A)	384 KB + 4 KB(1)	24 KB	
M30873FHAGP	PLQP0100KB-A (100P6Q-A)			
M30878MJA-XXXGP	PLQP0144KA-A (144P6Q-A)	512 KB	31 KB	Mask ROM
M30876MJA-XXXFP	PRQP0100JB-A (100P6S-A)			
M30876MJA-XXXGP	PLQP0100KB-A (100P6Q-A)			
M30875MHA-XXXGP	PLQP0144KA-A (144P6Q-A)	384 KB	24 KB	
M30873MHA-XXXGP	PLQP0100KB-A (100P6Q-A)			

NOTE:
1. Additional 4-Kbyte space is available for data flash memory.

Table 1.7 M32C/87 Group (3) (M32C/87B: no CAN module) Current as of Jul. 2008

Part Number	Package Code	ROM Capacity	RAM Capacity	Remarks
M3087BFLBGP	PLQP0144KA-A (144P6Q-A)	1 MB + 4 KB(1)	48 KB	Flash memory
M30879FLBFP	PRQP0100JB-A (100P6S-A)			
M30879FLBGP	PLQP0100KB-A (100P6Q-A)			
M3087BFKBGP	PLQP0144KA-A (144P6Q-A)	768 KB + 4 KB(1)		
M30879FKBGP	PLQP0100KB-A (100P6Q-A)			
M30878FJBGP	PLQP0144KA-A (144P6Q-A)	512 KB + 4 KB(1)	31 KB	
M30876FJBGP	PLQP0100KB-A (100P6Q-A)			
M30875FHBGP	PLQP0144KA-A (144P6Q-A)	384 KB + 4 KB(1)	24 KB	
M30873FHBGP	PLQP0100KB-A (100P6Q-A)			
M30878MJB-XXXGP	PLQP0144KA-A (144P6Q-A)	512 KB	31 KB	Mask ROM
M30876MJB-XXXFP	PRQP0100JB-A (100P6S-A)			
M30876MJB-XXXGP	PLQP0100KB-A (100P6Q-A)			
M30875MHB-XXXGP	PLQP0144KA-A (144P6Q-A)	384 KB	24 KB	
M30873MHB-XXXGP	PLQP0100KB-A (100P6Q-A)			

NOTE:
1. Additional 4-Kbyte space is available for data flash memory.

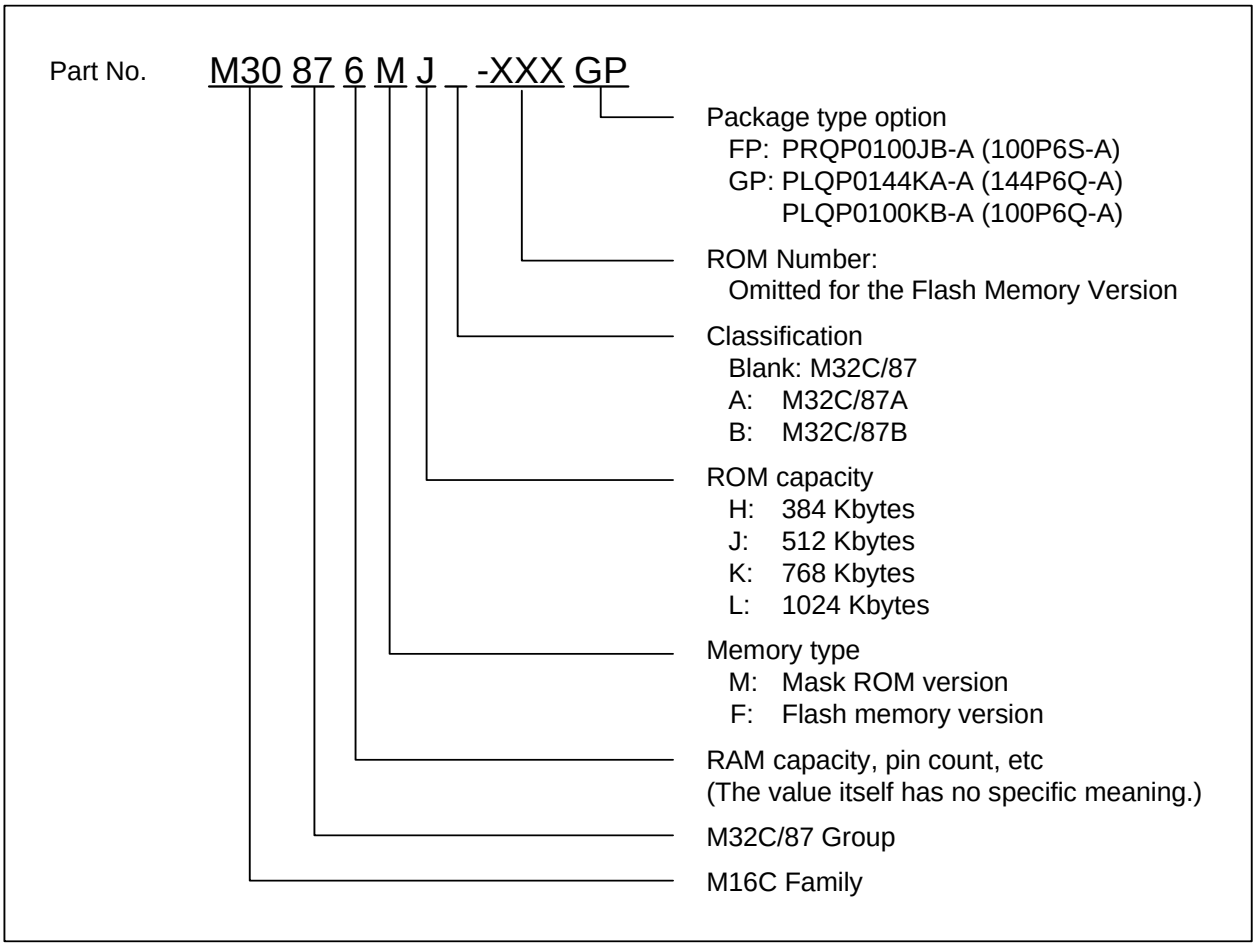


Figure 1.1 Product Numbering System

Table 1.10 144-Pin Package List of Pin Names (3/4)

Pin No.	Control Pin	Port	Interrupt Pin	Timer Pin	UART/CAN Pin	Intelligent I/O Pin	Analog Pin	Bus Control Pin
81		P3_5						A13,[A13/D13]
82		P3_4						A12,[A12/D12]
83		P3_3						A11,[A11/D11]
84		P3_2						A10,[A10/D10]
85		P3_1						A9,[A9/D9]
86		P12_4						
87		P12_3			$\overline{\text{CTS6}}$/$\overline{\text{RTS6}}$			
88		P12_2			RXD6			
89		P12_1			CLK6			
90		P12_0			TXD6			
91	VCC2							
92		P3_0						A8,[A8/D8]
93	VSS							
94		P2_7					AN2_7	A7,[A7/D7]
95		P2_6					AN2_6	A6,[A6/D6]
96		P2_5					AN2_5	A5,[A5/D5]
97		P2_4					AN2_4	A4,[A4/D4]
98		P2_3					AN2_3	A3,[A3/D3]
99		P2_2					AN2_2	A2,[A2/D2]
100		P2_1					AN2_1	A1,[A1/D1]
101		P2_0					AN2_0	A0,[A0/D0]
102		P1_7	$\overline{\text{INT5}}$					D15
103		P1_6	$\overline{\text{INT4}}$					D14
104		P1_5	$\overline{\text{INT3}}$					D13
105		P1_4						D12
106		P1_3						D11
107		P1_2						D10
108		P1_1						D9
109		P1_0						D8
110		P0_7					AN0_7	D7
111		P0_6					AN0_6	D6
112		P0_5					AN0_5	D5
113		P0_4					AN0_4	D4
114		P11_4						
115		P11_3				INPC1_3/OUTC1_3		
116		P11_2				INPC1_2/OUTC1_2/ ISRXD1		
117		P11_1				INPC1_1/OUTC1_1/ ISCLK1		
118		P11_0				INPC1_0/OUTC1_0/ ISTXD1		
119		P0_3					AN0_3	D3
120		P0_2					AN0_2	D2

Table 1.13 100-Pin Package List of Pin Names (2/3)

Pin No.		Control Pin	Port	Interrupt Pin	Timer Pin	UART/CAN Pin	Intelligent I/O Pin	Analog Pin	Bus Control Pin
FP	GP								
41	39		P5_5						$\overline{\text{HOLD}}$
42	40		P5_4						$\overline{\text{HLDA}}$/ALE
43	41	CLKOUT	P5_3						BCLK/ALE
44	42		P5_2						$\overline{\text{RD}}$
45	43		P5_1						$\overline{\text{WRH}}$/$\overline{\text{BHE}}$
46	44		P5_0						$\overline{\text{WRL}}$/$\overline{\text{WR}}$
47	45		P4_7						$\overline{\text{CS0}}$/A23
48	46		P4_6						$\overline{\text{CS1}}$/A22
49	47		P4_5						$\overline{\text{CS2}}$/A21
50	48		P4_4						$\overline{\text{CS3}}$/A20
51	49		P4_3						A19
52	50		P4_2						A18
53	51		P4_1						A17
54	52		P4_0						A16
55	53		P3_7						A15,[A15/D15]
56	54		P3_6						A14,[A14/D14]
57	55		P3_5						A13,[A13/D13]
58	56		P3_4						A12,[A12/D12]
59	57		P3_3						A11,[A11/D11]
60	58		P3_2						A10,[A10/D10]
61	59		P3_1						A9,[A9/D9]
62	60	VCC2							
63	61		P3_0						A8,[A8/D8]
64	62	VSS							
65	63		P2_7					AN2_7	A7,[A7/D7]
66	64		P2_6					AN2_6	A6,[A6/D6]
67	65		P2_5					AN2_5	A5,[A5/D5]
68	66		P2_4					AN2_4	A4,[A4/D4]
69	67		P2_3					AN2_3	A3,[A3/D3]
70	68		P2_2					AN2_2	A2,[A2/D2]
71	69		P2_1					AN2_1	A1,[A1/D1]
72	70		P2_0					AN2_0	A0,[A0/D0]

Table 1.18 Pin Functions (100-Pin and 144-Pin Package) (4/4)

Type	Symbol	I/O Type	Supply Voltage	Description
I/O port	P0_0 to P0_7, P1_0 to P1_7, P2_0 to P2_7, P3_0 to P3_7, P4_0 to P4_7, P5_0 to P5_7	I/O	VCC2	8-bit CMOS I/O ports. The Port Pi Direction Register (i = 0 to 15) determines if each pin is used as an input port or an output port. The Pull-Up Control Registers determine if the input ports, divided into groups of four, are pulled up or not.
	P6_0 to P6_7, P7_0 to P7_7, P9_0 to P9_7, P10_0 to P10_7	I/O	VCC1	These 8-bit I/O ports are functionally equivalent to P0. (P7_0 and P7_1 are N-channel open drain output.)
	P8_0 to P8_4 P8_6, P8_7	I/O	VCC1	These I/O ports are functionally equivalent to P0.
Input port	P8_5	I	VCC1	Shares the pin with $\overline{\text{NMI}}$. Input port to read $\overline{\text{NMI}}$ pin level.
Key input interrupt input	$\overline{\text{KI0}}$ to $\overline{\text{KI3}}$	I	VCC1	Key input interrupt input pins.

I: Input O: Output I/O: Input and output

Table 1.19 Pin Functions (144-Pin Package Only)

Type	Symbol	I/O Type	Supply Voltage	Description
$\overline{\text{INT}}$ Interrupt Input	$\overline{\text{INT6}}$ to $\overline{\text{INT8}}$	I	VCC1	$\overline{\text{INT}}$ interrupt input pins.
Serial interface	$\overline{\text{CTS6}}$	I	VCC1/ VCC2	Input pin to control data transmission.
	$\overline{\text{RTS6}}$	O	VCC1/ VCC2	Output pin to control data reception.
	CLK6	I/O	VCC1/ VCC2	Serial clock input/output pin.
	RXD6	I	VCC1/ VCC2	Serial data input pin.
	TXD6	O	VCC1/ VCC2	Serial data output pin.
Intelligent I/O	OUTC2_3 to OUTC2_7	O	VCC2	Output pins for the waveform generation function.
A/D converter	AN15_0 to AN15_7	I	VCC1	Analog input pins for the A/D converter.
I/O port	P11_0 to P11_4, P12_0 to P12_7, P13_0 to P13_7	I/O	VCC2	These I/O ports are functionally equivalent to P0.
	P14_0 to P14_6, P15_0 to P15_7	I/O	VCC1	These I/O ports are functionally equivalent to P0.

I: Input O: Output I/O: Input and output

4. Special Function Registers (SFRs)

Special Function Registers (SFRs) are the control registers of peripheral functions. Tables 4.1 to 4.20 list SFR address maps.

Table 4.1 SFR Address Map (1/20)

Address	Register	Symbol	After Reset
0000h			
0001h			
0002h			
0003h			
0004h	Processor Mode Register 0(1)	PM0	1000 0000b(CNVSS="L") 0000 0011b(CNVSS="H")
0005h	Processor Mode Register 1	PM1	00h
0006h	System Clock Control Register 0	CM0	0000 1000b
0007h	System Clock Control Register 1	CM1	0010 0000b
0008h			
0009h	Address Match Interrupt Enable Register	AIER	00h
000Ah	Protect Register	PRCR	XXXX 0000b
000Bh	External Data Bus Width Control Register	DS	XXXX 1000b(BYTE="L") XXXX 0000b(BYTE="H")
000Ch	Main Clock Division Register	MCD	XXX0 1000b
000Dh	Oscillation Stop Detection Register	CM2	00h
000Eh	Watchdog Timer Start Register	WDTS	XXh
000Fh	Watchdog Timer Control Register	WDC	00XX XXXXb
0010h	Address Match Interrupt Register 0	RMAD0	000000h
0011h			
0012h			
0013h	Processor Mode Register 2	PM2	00h
0014h	Address Match Interrupt Register 1	RMAD1	000000h
0015h			
0016h			
0017h	Voltage Detection Register 2	VCR2	00h
0018h	Address Match Interrupt Register 2	RMAD2	000000h
0019h			
001Ah			
001Bh	Voltage Detection Register 1	VCR1	0000 1000b
001Ch	Address Match Interrupt Register 3	RMAD3	000000h
001Dh			
001Eh			
001Fh			
0020h			
0021h			
0022h			
0023h			
0024h			
0025h			
0026h	PLL Control Register 0	PLC0	0001 X010b
0027h	PLL Control Register 1	PLC1	000X 0000b
0028h	Address Match Interrupt Register 4	RMAD4	000000h
0029h			
002Ah			
002Bh			
002Ch	Address Match Interrupt Register 5	RMAD5	000000h
002Dh			
002Eh			
002Fh	Vdet4 Detection Interrupt Register	D4INT	XX00 0000b

X: Undefined
Blank spaces are all reserved. No access is allowed.
NOTE:
1. Bits PM01 and PM00 in the PM0 register maintain values set before reset, even after software reset or watchdog timer reset has been performed.

Table 4.2 SFR Address Map (2/20)

Address	Register	Symbol	After Reset
0030h			
0031h			
0032h			
0033h			
0034h			
0035h			
0036h			
0037h			
0038h	Address Match Interrupt Register 6	RMAD6	000000h
0039h			
003Ah			
003Bh			
003Ch	Address Match Interrupt Register 7	RMAD7	000000h
003Dh			
003Eh			
003Fh			
0040h			
0041h			
0042h			
0043h			
0044h			
0045h			
0046h			
0047h			
0048h	External Space Wait Control Register 0	EWCR0	X0X0 0011b
0049h	External Space Wait Control Register 1	EWCR1	X0X0 0011b
004Ah	External Space Wait Control Register 2	EWCR2	X0X0 0011b
004Bh	External Space Wait Control Register 3	EWCR3	X0X0 0011b
004Ch			
004Dh			
004Eh			
004Fh			
0050h			
0051h			
0052h			
0053h			
0054h			
0055h	Flash Memory Control Register 1	FMR1	0000 0X0Xb
0056h			
0057h	Flash Memory Control Register 0	FMR0	0000 0001b(Flash Memory) XXXX XXX0b(Mask ROM)
0058h			
0059h			
005Ah			
005Bh			
005Ch			
005Dh			
005Eh			
005Fh			

X: Undefined
Blank spaces are all reserved. No access is allowed.

Table 4.4 SFR Address Map (4/20)

Address	Register	Symbol	After Reset
0090h	UART0 Transmit/NACK Interrupt Control Register	S0TIC	XXXX X000b
0091h	UART1/UART4 Bus Conflict Detection Interrupt Control Register	BCN1IC/BCN4IC	XXXX X000b
0092h	UART1 Transmit/NACK Interrupt Control Register	S1TIC	XXXX X000b
0093h	Key Input Interrupt Control Register	KUPIC	XXXX X000b
0094h	Timer B0 Interrupt Control Register	TB0IC	XXXX X000b
0095h	II/O Interrupt Control Register 1 / CAN1 Interrupt Control Register 1	IIO1IC/CAN4IC	XXXX X000b
0096h	Timer B2 Interrupt Control Register	TB2IC	XXXX X000b
0097h	II/O Interrupt Control Register 3	IIO3IC	XXXX X000b
0098h	Timer B4 Interrupt Control Register	TB4IC	XXXX X000b
0099h	II/O Interrupt Control Register 5 /CAN1 Interrupt Control Register 2	IIO5IC/CAN5IC	XXXX X000b
009Ah	$\overline{\text{INT4}}$ Interrupt Control Register	INT4IC	XX00 X000b
009Bh	II/O Interrupt Control Register 7	IIO7IC	XXXX X000b
009Ch	$\overline{\text{INT2}}$ Interrupt Control Register	INT2IC	XX00 X000b
009Dh	II/O Interrupt Control Register 9 / CAN0 Interrupt Control Register 0	IIO9IC/CAN0IC	XXXX X000b
009Eh	$\overline{\text{INT0}}$ Interrupt Control Register	INT0IC	XX00 X000b
009Fh	Exit Priority Register	RLVL	XXXX 0000b
00A0h	Interrupt Request Register 0	IIO0IR	0000 000Xb
00A1h	Interrupt Request Register 1	IIO1IR	0000 000Xb
00A2h	Interrupt Request Register 2	IIO2IR	0000 000Xb
00A3h	Interrupt Request Register 3	IIO3IR	0000 000Xb
00A4h	Interrupt Request Register 4	IIO4IR	0000 000Xb
00A5h	Interrupt Request Register 5	IIO5IR	0000 000Xb
00A6h	Interrupt Request Register 6	IIO6IR	0000 000Xb
00A7h	Interrupt Request Register 7	IIO7IR	0000 000Xb
00A8h	Interrupt Request Register 8	IIO8IR	0000 000Xb
00A9h	Interrupt Request Register 9	IIO9IR	0000 000Xb
00AAh	Interrupt Request Register 10	IIO10IR	0000 000Xb
00ABh	Interrupt Request Register 11	IIO11IR	0000 000Xb
00ACh			
00ADh			
00AEh			
00AFh			
00B0h	Interrupt Enable Register 0	IIO0IE	00h
00B1h	Interrupt Enable Register 1	IIO1IE	00h
00B2h	Interrupt Enable Register 2	IIO2IE	00h
00B3h	Interrupt Enable Register 3	IIO3IE	00h
00B4h	Interrupt Enable Register 4	IIO4IE	00h
00B5h	Interrupt Enable Register 5	IIO5IE	00h
00B6h	Interrupt Enable Register 6	IIO6IE	00h
00B7h	Interrupt Enable Register 7	IIO7IE	00h
00B8h	Interrupt Enable Register 8	IIO8IE	00h
00B9h	Interrupt Enable Register 9	IIO9IE	00h
00BAh	Interrupt Enable Register 10	IIO10IE	00h
00BBh	Interrupt Enable Register 11	IIO11IE	00h
00BCh			
00BDh			
00BEh			
00BFh to 00DFh			

X: Undefined
Blank spaces are all reserved. No access is allowed.

Table 4.13 SFR Address Map (13/20)

Address	Register[3][4]	Symbol	After Reset
02B0h	CAN1 Message Slot 0 Control Register / CAN1 Local Mask Register A Standard ID0	C1MCTL0 / C1LMAR0	0000 0000b[1][2]/ XXX0 0000b[1][2]
02B1h	CAN1 Message Slot 1 Control Register / CAN1 Local Mask Register A Standard ID1	C1MCTL1 / C1LMAR1	0000 0000b[1][2]/ XX00 0000b[1][2]
02B2h	CAN1 Message Slot 2 Control Register / CAN1 Local Mask Register A Extended ID0	C1MCTL2 / C1LMAR2	0000 0000b[1][2]/ XXXX 0000b[1][2]
02B3h	CAN1 Message Slot 3 Control Register / CAN1 Local Mask Register A Extended ID1	C1MCTL3 / C1LMAR3	00h[1][2]/ 00h[1][2]
02B4h	CAN1 Message Slot 4 Control Register / CAN1 Local Mask Register A Extended ID2	C1MCTL4 / C1LMAR4	0000 0000b[1][2]/ XX00 0000b[1][2]
02B5h	CAN1 Message Slot 5 Control Register	C1MCTL5	00h[1][2]
02B6h	CAN1 Message Slot 6 Control Register	C1MCTL6	00h[1][2]
02B7h	CAN1 Message Slot 7 Control Register	C1MCTL7	00h[1][2]
02B8h	CAN1 Message Slot 8 Control Register / CAN1 Local Mask Register B Standard ID0	C1MCTL8 / C1LMBR0	0000 0000b[1][2]/ XXX0 0000b[1][2]
02B9h	CAN1 Message Slot 9 Control Register / CAN1 Local Mask Register B Standard ID1	C1MCTL9 / C1LMBR1	0000 0000b[1][2]/ XX00 0000b[1][2]
02BAh	CAN1 Message Slot 10 Control Register / CAN1 Local Mask Register B Extended ID0	C1MCTL10 / C1LMBR2	0000 0000b[1][2]/ XXXX 0000b[1][2]
02BBh	CAN1 Message Slot 11 Control Register / CAN1 Local Mask Register B Extended ID1	C1MCTL11 / C1LMBR3	00h[1][2]/ 00h[1][2]
02BCh	CAN1 Message Slot 12 Control Register / CAN1 Local Mask Register B Extended ID2	C1MCTL12 / C1LMBR4	0000 0000b[1][2]/ XX00 0000b[1][2]
02BDh	CAN1 Message Slot 13 Control Register	C1MCTL13	00h[1][2]
02BEh	CAN1 Message Slot 14 Control Register	C1MCTL14	00h[1][2]
02BFh	CAN1 Message Slot 15 Control Register	C1MCTL15	00h[1][2]

X: Undefined
Blank spaces are all reserved. No access is allowed.
NOTES:
1. The BANKSEL bit in the C1CTLR1 register can switch functions for addresses 02A0h to 02BFh.
2. Values are obtained by setting the SLEEP bit in the C1SLPR register to “1” (sleep mode exited) after reset and supplying a clock to the CAN module.
3. The CAN-associated registers (allocated in addresses 01E0h to 02BFh) cannot be used in M32C/87B. In M32C/87A, only CAN0-associated registers can be used.
4. Set the PM13 bit in the PM1 register to 1 (2 wait states for SFR area) before accessing the CAN-associated registers.

Table 4.18 SFR Address Map (18/20)

Address	Register	Symbol	After Reset
0380h	A/D0 Register 0	AD00	00XXh
0381h			
0382h	A/D0 Register 1	AD01	00XXh
0383h			
0384h	A/D0 Register 2	AD02	00XXh
0385h			
0386h	A/D0 Register 3	AD03	00XXh
0387h			
0388h	A/D0 Register 4	AD04	00XXh
0389h			
038Ah	A/D0 Register 5	AD05	00XXh
038Bh			
038Ch	A/D0 Register 6	AD06	00XXh
038Dh			
038Eh	A/D0 Register 7	AD07	00XXh
038Fh			
0390h			
0391h			
0392h	A/D0 Control Register 4	AD0CON4	XXXX 00XXb
0393h			
0394h	A/D0 Control Register 2	AD0CON2	XX0X X000b
0395h	A/D0 Control Register 3	AD0CON3	XXXX X000b
0396h	A/D0 Control Register 0	AD0CON0	00h
0397h	A/D0 Control Register 1	AD0CON1	00h
0398h	D/A Register 0	DA0	XXh
0399h			
039Ah	D/A Register 1	DA1	XXh
039Bh			
039Ch	D/A Control Register	DACON	XXXX XX00b
039Dh	D/A Control Register 1	DACON1	XXXX 0000b
039Eh			
039Fh			

X: Undefined
Blank spaces are all reserved. No access is allowed.

VCC1 = VCC2 = 5V

Timing Requirements
(VCC1 = VCC2 = 4.2 to 5.5 V, VSS = 0 V, Topr = -20 to 85°C unless otherwise specified)

Table 5.13 External Clock Input

Symbol	Parameter	Standard		Unit
		Min.	Max.	
tc	External clock input cycle time	31.25		ns
tw(H)	External clock input high (“H”) pulse width	13.75		ns
tw(L)	External clock input low (“L”) pulse width	13.75		ns
tr	External clock rise time		5	ns
tf	External clock fall time		5	ns

Table 5.14 Timer A Input (Count Source Input in Event Counter Mode)

Symbol	Parameter	Standard		Unit
		Min.	Max.	
tc(TA)	TAiIN input cycle time	100		ns
tw(TAH)	TAiIN input high (“H”) pulse width	40		ns
tw(TAL)	TAiIN input low (“L”) pulse width	40		ns

i = 0 to 4

Table 5.15 Timer A Input (Gate Signal Input in Timer Mode)

Symbol	Parameter	Standard		Unit
		Min.	Max.	
tc(TA)	TAiIN input cycle time	400		ns
tw(TAH)	TAiIN input high (“H”) pulse width	200		ns
tw(TAL)	TAiIN input low (“L”) pulse width	200		ns

i = 0 to 4

Table 5.16 Timer A Input (External Trigger Input in One-Shot Timer Mode)

Symbol	Parameter	Standard		Unit
		Min.	Max.	
tc(TA)	TAiIN input cycle time	200		ns
tw(TAH)	TAiIN input high (“H”) pulse width	100		ns
tw(TAL)	TAiIN input low (“L”) pulse width	100		ns

i = 0 to 4

Table 5.17 Timer A Input (External Trigger Input in Pulse Width Modulation Mode)

Symbol	Parameter	Standard		Unit
		Min.	Max.	
tw(TAH)	TAiIN input high (“H”) pulse width	100		ns
tw(TAL)	TAiIN input low (“L”) pulse width	100		ns

i = 0 to 4

VCC1 = VCC2 = 5V

Timing Requirements
(VCC1 = VCC2 = 4.2 to 5.5 V, VSS = 0 V, Topr = -20 to 85°C unless otherwise specified)

Table 5.27 External Interrupt $\overline{INTi}$ Input (Edge Sensitive)

Symbol	Parameter	Standard		Unit
		Min.	Max.	
tw(INH)	$\overline{INTi}$ input high (“H”) pulse width	250		ns
tw(INL)	$\overline{INTi}$ input low (“L”) pulse width	250		ns

i = 0 to 8(1)

NOTE:
1. $\overline{INT6}$ to $\overline{INT8}$ are provided in the 144-pin package only.

VCC1 = VCC2 = 3.3 V

Timing Requirements
(VCC1 = VCC2 = 3.0 to 3.6 V, VSS = 0 V, Topr = -20 to 85°C unless otherwise specified)

Table 5.41 Timer A Input (Counter Increment/Decrement Input in Event Counter Mode)

Symbol	Parameter	Standard		Unit
		Min.	Max.	
tc(UP)	TAiOUT input cycle time	2000		ns
tw(UPH)	TAiOUT input high (“H”) pulse width	1000		ns
tw(UPL)	TAiOUT input low (“L”) pulse width	1000		ns
tsu(UP-TIN)	TAiOUT input setup time	400		ns
th(TIN-UP)	TAiOUT input hold time	400		ns

i = 0 to 4

Table 5.42 Timer A Input (Two-Phase Pulse Input in Event Counter Mode)

Symbol	Parameter	Standard		Unit
		Min.	Max.	
tc(TA)	TAiIN input cycle time	2		µs
tsu(TAIN-TAOUT)	TAiOUT input setup time	500		ns
tsu(TAOUT-TAIN)	TAiIN input setup time	500		ns

i = 0 to 4

Table 5.43 Timer B Input (Count Source Input in Event Counter Mode)

Symbol	Parameter	Standard		Unit
		Min.	Max.	
tc(TB)	TBiIN input cycle time (counted on one edge)	100		ns
tw(TBH)	TBiIN input high (“H”) pulse width (counted on one edge)	40		ns
tw(TBL)	TBiIN input low (“L”) pulse width (counted on one edge)	40		ns
tc(TB)	TBiIN input cycle time (counted on both edges)	200		ns
tw(TBH)	TBiIN input high (“H”) pulse width (counted on both edges)	80		ns
tw(TBL)	TBiIN input low (“L”) pulse width (counted on both edges)	80		ns

i = 0 to 5

Table 5.44 Timer B Input (Pulse Period Measurement Mode)

Symbol	Parameter	Standard		Unit
		Min.	Max.	
tc(TB)	TBiIN input cycle time	400		ns
tw(TBH)	TBiIN input high (“H”) pulse width	200		ns
tw(TBL)	TBiIN input low (“L”) pulse width	200		ns

i = 0 to 5

Table 5.45 Timer B Input (Pulse Width Measurement Mode)

Symbol	Parameter	Standard		Unit
		Min.	Max.	
tc(TB)	TBiIN input cycle time	400		ns
tw(TBH)	TBiIN input high (“H”) pulse width	200		ns
tw(TBL)	TBiIN input low (“L”) pulse width	200		ns

i = 0 to 5

VCC1 = VCC2 = 3.3 V

Timing Requirements
(VCC1 = VCC2 = 3.0 to 3.6 V, VSS = 0 V, Topr = -20 to 85°C unless otherwise specified)

Table 5.46 A/D Trigger Input

Symbol	Parameter	Standard		Unit
		Min.	Max.	
tc(AD)	$\overline{\text{ADTRG}}$ input cycle time (required for trigger)	1000		ns
tw(ADL)	$\overline{\text{ADTRG}}$ input low (“L”) pulse width	125		ns

Table 5.47 Serial Interface

Symbol	Parameter	Standard		Unit
		Min.	Max.	
tc(CK)	CLKi input cycle time	200		ns
tw(CKH)	CLKi input high (“H”) pulse width	100		ns
tw(CKL)	CLKi input low (“L”) pulse width	100		ns
td(C-Q)	TXDi output delay time		80	ns
th(C-Q)	TXDi output hold time	0		ns
tsu(D-C)	RXDi input setup time	70		ns
th(C-D)	RXDi input hold time	90		ns

i = 0 to 6

Table 5.48 Intelligent I/O Communication Function (Groups 0 and 1)

Symbol	Parameter	Standard		Unit
		Min.	Max.	
tc(CK)	ISCLKi input cycle time	600		ns
tw(CKH)	ISCLKi input high (“H”) pulse width	300		ns
tw(CKL)	ISCLKi input low (“L”) pulse width	300		ns
td(C-Q)	ISTXDi output delay time		100	ns
th(C-Q)	ISTXDi output hold time	0		ns
tsu(D-C)	ISRXDi input setup time	100		ns
th(C-D)	ISRXDi input hold time	100		ns

i = 0, 1

Table 5.49 Intelligent I/O Communication Function (Group 2)

Symbol	Parameter	Standard		Unit
		Min.	Max.	
tc(CK)	ISCLK2 input cycle time	600		ns
tw(CKH)	ISCLK2 input high (“H”) pulse width	300		ns
tw(CKL)	ISCLK2 input low (“L”) pulse width	300		ns
td(C-Q)	ISTXD2 output delay time		180	ns
th(C-Q)	ISTXD2 output hold time	0		ns
tsu(D-C)	ISRXD2 input setup time	150		ns
th(C-D)	ISRXD2 input hold time	100		ns

VCC1 = VCC2 = 3.3 V

Switching Characteristics
(VCC1 = VCC2 = 3.0 to 3.6 V, VSS = 0 V, Topr = -20 to 85°C unless otherwise specified)

Table 5.52 Memory Expansion Mode and Microprocessor Mode (when accessing external memory space)

Symbol	Parameter	Measurement Condition	Standard		Unit
			Min.	Max.	
td(BCLK-AD)	Address output delay time	See Figure 5.2		18	ns
th(BCLK-AD)	Address output hold time (BCLK standard)		-3		ns
th(RD-AD)	Address output hold time (RD standard)(3)		0		ns
th(WR-AD)	Address output hold time (WR standard)(3)		(note 1)		ns
td(BCLK-CS)	Chip-select signal output delay time			18	ns
th(BCLK-CS)	Chip-select signal output hold time (BCLK standard)		-3		ns
th(RD-CS)	Chip-select signal output hold time (RD standard)(3)		0		ns
th(WR-CS)	Chip-select signal output hold time (WR standard)(3)		(note 1)		ns
td(BCLK-RD)	RD signal output delay time			18	ns
th(BCLK-RD)	RD signal output hold time		-5		ns
td(BCLK-WR)	WR signal output delay time			18	ns
th(BCLK-WR)	WR signal output hold time		0		ns
td(DB-WR)	Data output delay time (WR standard)		(note 2)		ns
th(WR-DB)	Data output hold time (WR standard)(3)		(note 1)		ns
tw(WR)	WR output width		(note 2)		ns

NOTES:

1. Values, which depend on BCLK frequency, can be obtained from the following equations.

$$th(WR\text{-}DB) = \frac{10^9}{f(BCLK) \times 2} - 20\ [ns]$$

$$th(WR\text{-}AD) = \frac{10^9}{f(BCLK) \times 2} - 15\ [ns]$$

$$th(WR\text{-}CS) = \frac{10^9}{f(BCLK) \times 2} - 10\ [ns]$$

2. Values, which depend on BCLK frequency and external bus cycles, can be obtained from the following equations.

$$td(DB\text{-}WR) = \frac{10^9 \times m}{f(BCLK)} - 20\ [ns]\ (\text{if external bus cycle is } a\phi + b\phi,\ m = b)$$

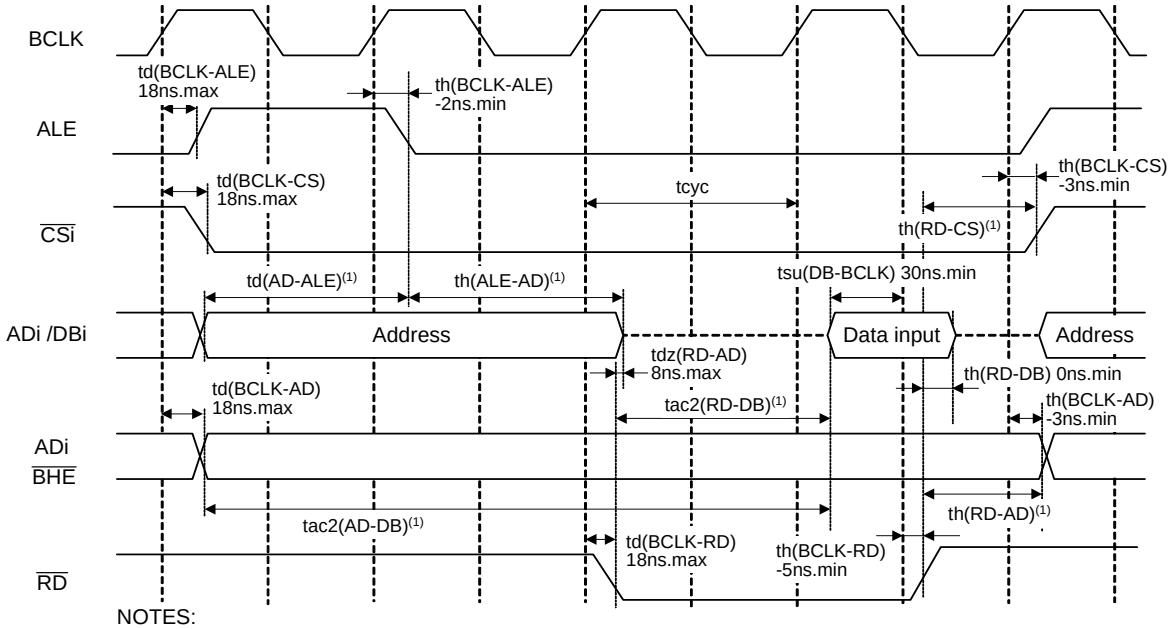
$$tw(WR) = \frac{10^9 \times n}{f(BCLK) \times 2} - 15\ [ns]\ (\text{if external bus cycle is } a\phi + b\phi,\ n = (b \times 2) - 1)$$

3. tc [ns] is added when recovery cycle is inserted.

Memory Expansion Mode and Microprocessor Mode
(when accessing an external memory space with the multiplexed bus)

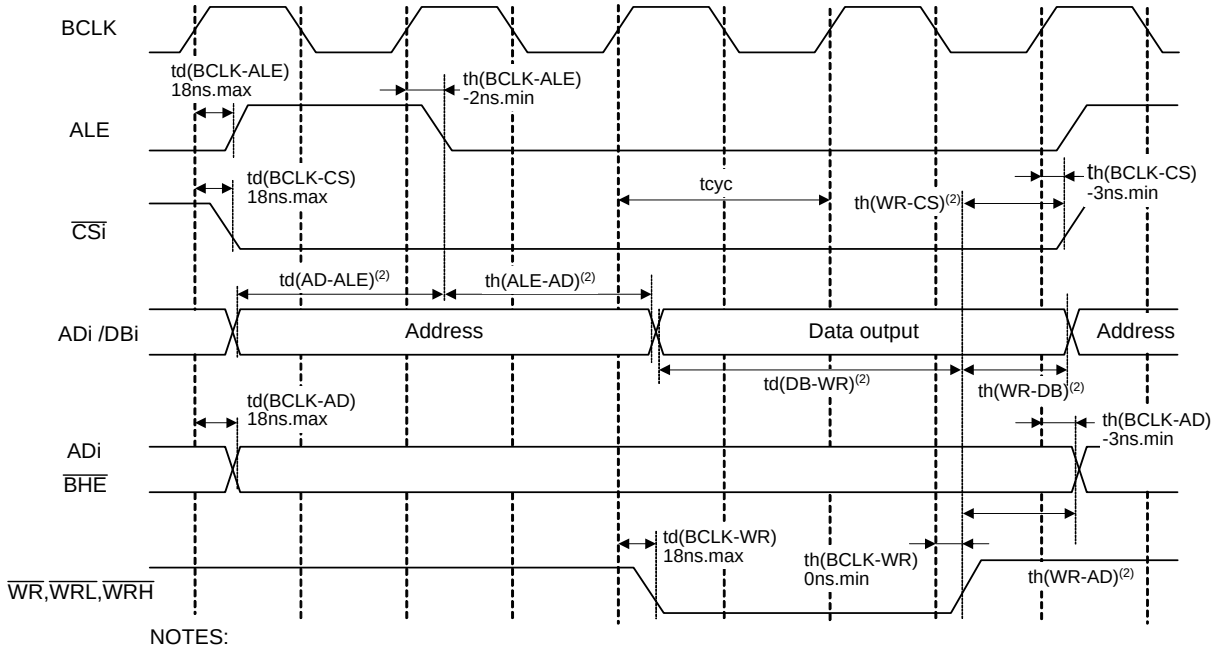
VCC1=VCC2=3.3V

Read Timing (2ϕ + 2ϕ Bus Cycle)



NOTES:
1. Varies with operation frequency:
td(AD-ALE) = (tcyc / 2 x n - 20) ns.min (if external bus cycle aϕ + bϕ, n = a)
th(ALE-AD) = (tcyc / 2 x n - 20) ns.min (if external bus cycle aϕ + bϕ, n = a)
th(RD-AD) = (tcyc / 2 - 10) ns.min, th(RD-CS) = (tcyc / 2 - 10) ns.min
tac2(RD-DB) = (tcyc / 2 x m - 35) ns.max (if external bus cycle aϕ + bϕ, m = (b x 2) - 1)
tac2(AD-DB) = (tcyc / 2 x p - 35) ns.max (if external bus cycle aϕ + bϕ, p = {(a + b - 1) x 2} + 1)

Write Timing (2ϕ + 2ϕ Bus Cycle)



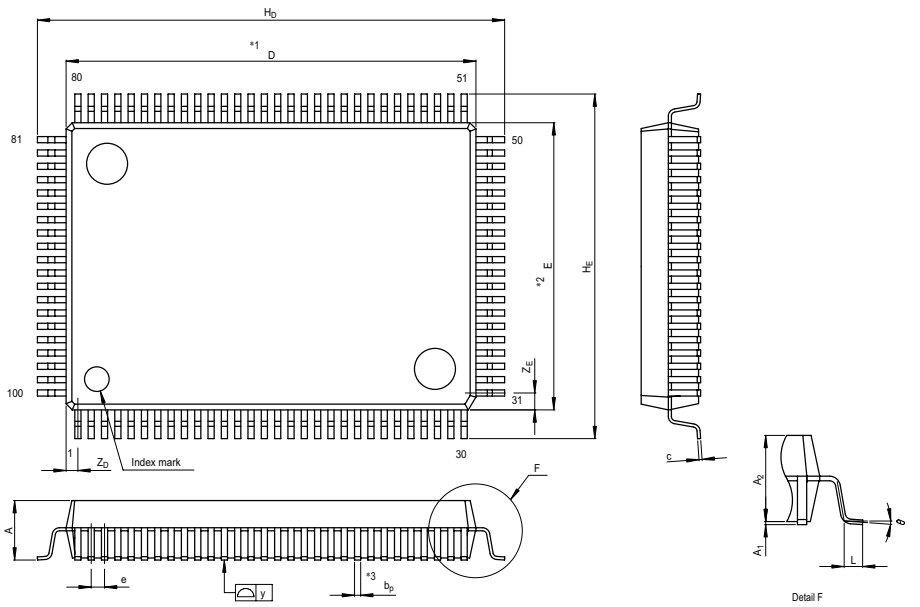
NOTES:
1. Varies with operation frequency:
td(AD-ALE) = (tcyc / 2 x n - 20) ns.min (if external bus cycle aϕ + bϕ, n = a)
th(ALE-AD) = (tcyc / 2 x n - 20) ns.min (if external bus cycle aϕ + bϕ, n = a)
th(WR-AD) = (tcyc / 2 - 15) ns.min, th(WR-CS) = (tcyc / 2 - 10) ns.min
th(WR-DB) = (tcyc / 2 - 20) ns.min
td(DB-WR) = (tcyc / 2 x m - 25) ns.min (if external bus cycle aϕ + bϕ, m = (b x 2) - 1)

$$tcyc = \frac{10^9}{f(BCLK)}$$

Measurement Conditions:
- VCC1 = VCC2 = 3.0 to 3.6 V
- Input high and low voltage VIH = 1.5 V, VIL = 0.5 V
- Output high and low voltage VOH = 1.5 V, VOL = 1.5 V

Figure 5.10 VCC1 = VCC2 = 3.3 V Timing Diagram (4/4)

JEITA Package Code	RENESAS Code	Previous Code	MASS[Typ.]
P-QFP100-14x20-0.65	PRQP0100JB-A	100P6S-A	1.6g



NOTE)
1. DIMENSIONS "*1" AND "*2" DO NOT INCLUDE MOLD FLASH.
2. DIMENSION "*3" DOES NOT INCLUDE TRIM OFFSET.

Reference Symbol	Dimension in Millimeters		
	Min	Nom	Max
D	19.8	20.0	20.2
E	13.8	14.0	14.2
A_2	—	2.8	—
H_D	22.5	22.8	23.1
H_E	16.5	16.8	17.1
A	—	—	3.05
A_1	0	0.1	0.2
b_p	0.25	0.3	0.4
c	0.13	0.15	0.2
θ	0°	—	10°
e	0.5	0.65	0.8
y	—	—	0.10
Z_D	—	0.575	—
Z_E	—	0.825	—
L	0.4	0.6	0.8

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Rev.	Date	Description	
		Page	Summary
			Electrical Characteristics
		57	• **Table 5.22 Memory Expansion Mode and Microprocessor Mode** *th(WR-DB)* expression on note 1 modified
		58	• **Table 5.23 Memory Expansion Mode and Microprocessor Mode** *th(WR-DB)* expression on note 1 modified; *th(ALE-AD)* expression on note 4 modified
		60	• **Figure 5.3 Vcc1=Vcc2=5V Timing Diagram (1)** *tac1(RD-DB)* expression on note 2 modified; *th(WR-DB)* and *tw(ER)* expressions on note 3 modified; *tcyc* expression added
		61	• **Figure 5.4 Vcc1=Vcc2=5V Timing Diagram (2)** *tac2(RD-DB) and tac2(AD-DB)* expressions on note 1 modified; *th(ALE-AD)* expressions on notes 1 and 2 modified; *td(DB-WR)* expression on note 2 modified; *tcyc* expression added
		62	• **Figure 5.5 Vcc1=Vcc2=5V Timing Diagram (3)** $\overline{\text{NMI}}$ input diagram added
		64	• **Table 5.24 Electrical Characteristics** V_{OH} values changed**;** R_{PULLUP} and Icc values modified
		65	• **Table 5.25 A/D Conversion Characteristics** tCONV value modified
		66	• **Table 5.28 Memory Expansion Mode and Microprocessor Mode** *tac1(RD-DB)* expression on note 1 modified; *tac2(RD-DB)* expression on note 1 added
		69	• **Table 5.40 Memory Expansion Mode and Microprocessor Mode** *th(BCLK-AD), th(BCLK-CS)* and *th(BCLK-RD)* values modified; *th(WR-AD)* expression on note 1 modified
		70	• **Table 5.41 Memory Expansion Mode and Microprocessor Mode** *th(BCLK-AD), th(BCLK-CS)* and *th(BCLK-RD)* values modified; *th(WR-AD)* expression on note 1 modified; *th(ALE-AD)* expression on note 4 modified
		71	• **Figure 5.7 Vcc1=Vcc2=3.3V Timing Diagram (1)** *th(BCLK-AD), th(BCLK-CS)* and *th(BCLK-RD)* values modified; *tac1(AD-DB)* expression on note 2 modified; *th(WR-DB)*, *th(WR-AD) and tw(WR)* expression on note 3 modified; *tcyc* expression added
		72	• **Figure 5.8 Vcc1=Vcc2=3.3V Timing Diagram (2)** *tac2(RD-DB) and tac1(AD-DB)* expressions on note 1 modified; *th(ALE-AD)* expressions on notes 1 and 2 modified; *td(WR-AD)*, *td(DB-WR) and th(WR-DB)* expressions on note 2 modified; *tcyc* expression added
		73	• **Figure 5.9 Vcc1=Vcc2=3.3V Timing Diagram (3)** $\overline{\text{NMI}}$ input diagram added
1.01	Aug. 29, 05		Overview
		17	• **Tables 1.6 Pin Description** Intelligent I/O functions modified
			Special Function Register (SFR)
		29	• The G1BCR0 register Value after reset modified
		29	• The G1BCR1 register Value after reset modified
			Electrical Characteristics
		49	• **Table 5.3 Electrical Characteristics** Icc standard value modified

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Rev.	Date	Description	
		Page	Summary
		46	**Special Function Registers (SFRs)** • **Table 4.20** A value of After Reset column in 03FFh modified